TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74ACT138FN

#### 3-to-8 Line Decoder

The TC74ACT138 is an advanced high speed CMOS 3-to-8 LINE DECODER fabricated with silicon gate and double-layer metal wiring  $C^2MOS$  technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

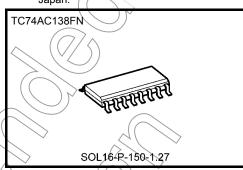
This device may be used as a level converter for interfacing TTL or NMOS to High Speed CMOS. The inputs are compatible with TTL, NMOS and CMOS output voltage levels.

When the device is enabled, 3 Binary Select inputs (A, B and C) determine which one of the outputs  $(\overline{Y}0 - \overline{Y}7)$  will go low.

When enable input G1 is held low or either  $\overline{G}2A$  or  $\overline{G}2B$  is held high, decoding function is inhibited and all outputs go high.

G1, G2A, and G2B inputs are provided to ease cascade connection and for use as an address decoder for memory systems.

Note: xxxFN (JEDEC SOP) is not available in Japan.



Weight SOL16-P-150-1.27

); 0.13 g (typ.)

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

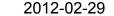
- High speed:  $t_{pd} = 6.0$  ns (typ.) at  $V_{CC} = 5$  V
- Low power dissipation:  $I_{CC} = 8 \mu A \text{ (max)}$  at  $Ta = 25^{\circ}C$
- Compatible with TTL outputs: V<sub>IL</sub> = 0.8 V (max)

 $V_{IH} \neq 2.0 V (min)$ 

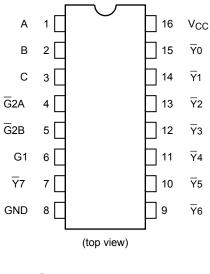
• Symmetrical output impedance: | IOH = IOL = 24 mA (min)

Capability of driving  $50 \Omega$  transmission lines.

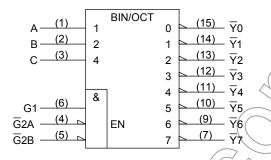
- Balanced propagation delays: tpLH ~ tpHL
- Pin and function compatible with 74F138



## **Pin Assignment**



# **IEC Logic Symbol**



#### **Truth Table**

iuiii i	abic							1	1	$\rangle$					
	Inputs Outputs														
Enable		Select			<u></u>	Ţ <sub>1</sub> ((	$\overrightarrow{X}_{2}$	<u>7</u> 3	<u>7</u> 4	<u>7</u> 5	<del>7</del> 6	<del>7</del> 7	Selected Output		
G1	G <sub>2</sub> A	G2B ⟨	$\langle c \rangle$	  B	⊃A	_			) 13	14	13	10	1 7	·	
L	Х	Х	X	X	Х	‡/	4	H	Н	Н	Н	Н	Н	None	
Х	Н	X	Х	×	Х	$\not$	E	Н	Н	Н	Н	Н	Н	None	
Х	Х	4	X	Х	Х	Н	<del> </del>	Н	Н	Н	Н	Н	Н	None	
Н	L	\ \ (	$\mathcal{H}$	L	L (	_L	Η	Н	Н	Н	Н	Н	Н	₹0	
Н	_ L (	L	L	L	ı	<u> </u>	L	Н	Н	Н	Н	Н	Н	<del>Y</del> 1	
Н	1	$\mathcal{H}$		H	(	<u> </u>	Η	L	Н	Н	Н	Н	Н	₹2	
(H_	1	<i>†</i>	L	$\hat{\gg}$	$\neq$	))	Η	Н	L	Н	Н	Н	Н	<del>-</del> 73	
Н	7	L	Н	3	)	Η	Η	Н	Н	L	Н	Н	Н	<del>Y</del> 4	
Н	$\searrow$	L	Н	L	/ <del>*</del>	Η	Η	Н	Н	Н	L	Н	Н	<del>Y</del> 5	
Н	L	L	Н	Н	L	Н	Н	Н	Н	Н	Н	L	Н	<del>Y</del> 6	
Н	L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	₹7	

X: Don't care

DMUX

2

3

5

6

0

(1)

(2)

(3)

(6)

(4)

(5)

В

C-

G<sub>2</sub>A

G<sub>2</sub>B

(15) <del>Y</del>0

(14) <u>Y</u>1

(13) <u>Y</u>2

(12) <sub>Y3</sub>

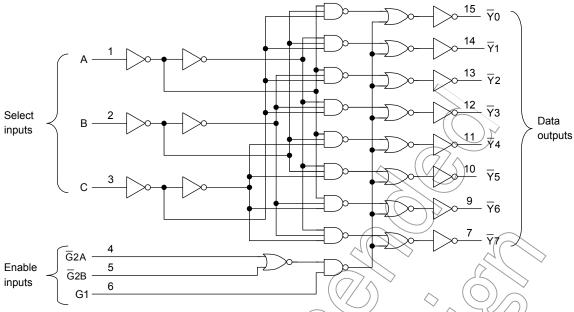
(11) <sub>Y4</sub>

(10) <sub>Y5</sub>

(9) <u>Y</u>6

(7) <u>Y</u>7

### **Logic Diagram**



# **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	lık	±20	mA
Output diode current	lok	±50	mA
DC output current	TUOL		mA
DC V <sub>CC</sub> /ground current	(\local_cc))	±200	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

## Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	4.5 to 5.5	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	−40 to 85	°C
Input rise and fall time	dt/dV	0 to 10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition				Ta = 25°C			Ta = −40 to 85°C		- Unit
Characteristics	Symbol				V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Offic
High-level input voltage	V <sub>IH</sub>		-		4.5 to 5.5	2.0	_		2.0	l	٧
Low-level input voltage	V <sub>IL</sub>		-		4.5 to 5.5	- <	(0)	0.8		0.8	٧
	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or	I <sub>OH</sub> = -50 μA		4.5	4.4	4.5		4.4	1	
High-level output voltage			I <sub>OH</sub> = −24 mA		4.5	3.94 (	7/	→ <b>–</b>	3.80	_	V
3.33		V <sub>IL</sub>	I <sub>OH</sub> = -75 mA	(Note)	5.5			_	3.85	Max —	
		V <sub>IN</sub>	I <sub>OL</sub> = 50 μA		4.5	1(-/	0.0	0.1	4	0.1	
Low-level output voltage	$V_{OL}$	= V <sub>IH</sub> or	I <sub>OL</sub> = 24 mA		4.5	1	_	0.36	>//	0.44	V
		V <sub>IL</sub>	I <sub>OL</sub> = 75 mA	(Note)	(5.5)	\ <del>\</del>		+(	<u></u>	0.8	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>C</sub>	<sub>C</sub> or GND		5.5	<u> </u>	_	±0.1		±1.0	μΑ
	Icc	V <sub>IN</sub> = V <sub>C</sub>	C or GND		5.5	_	-((	8.0	>	80.0	μΑ
Quiescent supply current	IC		: V <sub>IN</sub> = 3.4 V out: V <sub>CC</sub> or GND		5.5			1.35	_	1.5	mA

Note: This spec indicates the capability of driving 50 Q transmission lines.

One output should be tested at a time for a 10 ms maximum duration.

# AC Characteristics ( $C_L = 50 \text{ pF}, R_L = 500 \Omega$ , input: $t_r = t_f = 3 \text{ ns}$ )

		- / _ /	^						
Characteristics	Symbol	Test Condition	Test Condition			Ta = 25°C			Unit
	(		VCC (V)	Min	Тур.	Max	Min	Max	
Propagation delay time $ (A, B, C-\overline{Y}\ ) $	t <sub>pLH</sub>		5,0 ± 0.5	_	6.7	10.1	1.0	11.5	ns
Propagation delay time (G1- \overline{Y})	t <sub>pLH</sub>		5.0 ± 0.5	_	6.8	10.5	1.0	12.0	ns
Propagation delay time	t <sub>pLH</sub>		5.0 ± 0.5	_	6.9	11.0	1.0	12.5	ns
Input capacitance	C <sub>IN</sub> >			_	5	10	_	10	pF
Power dissipation capacitance	CPD		(Note)	_	55	_	_	_	pF

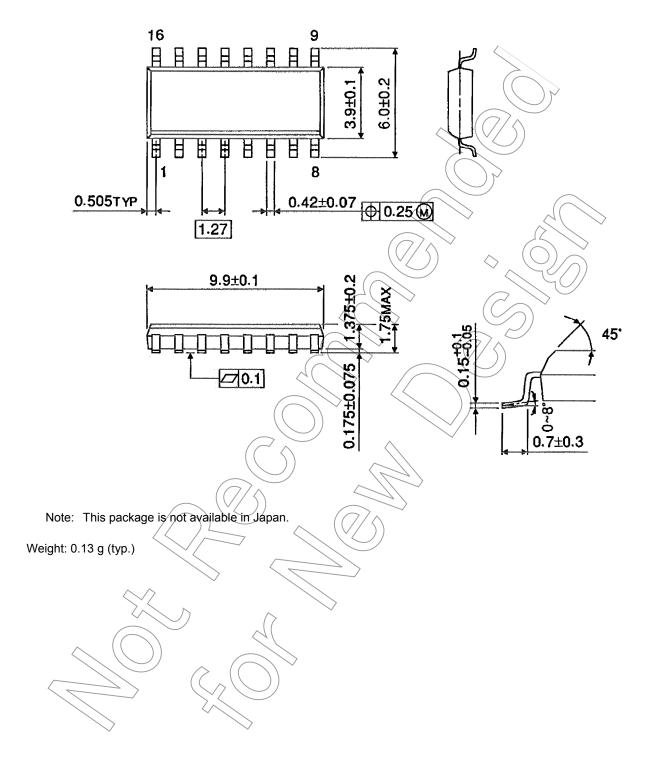
Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$ 

# **Package Dimensions (Note)**

SOL16-P-150-1.27 Unit: mm



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